1. General description

Nexperia introduces leading edge Silicon Carbide (SiC) Schottky diode for ultra high performance, low loss, high efficiency power conversion applications. The SiC Schottky diode encapsulated in a Real-2-Pin R2P (TO-252-2) Surface-Mounted Device (SMD) power plastic package offers temperature independent capacitive turn-off, zero recovery switching behavior combined with an outstanding figure-of-merit ($Q_C \times V_F$). The Merged PiN Schottky (MPS) diode improves the robustness expressed in a high I_{FSM} .

2. Features and benefits

- · Zero forward and reverse recovery
- · Temperature independent fast and smooth switching performance
- Outstanding figure-of-merit (Q_c x V_F)
- High I_{FSM} capability
- · High power density
- · Reduced system cost
- System miniaturization
- Reduced EMI

3. Applications

- Switch Mode Power Supply (SMPS)
- AC-DC and DC-DC converter
- · Battery charging infrastructure
- Server and telecom power supply
- Uninterruptible Power Supply (UPS)
- Photovoltaic inverters

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DC}	DC blocking voltage		650	-	-	V
I _F	forward current	T _c ≤ 122 °C; δ = 1	-	-	10	Α
Q_C	total capacitive charge	$V_R = 400 \text{ V}; \text{ dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s}; \text{ I}_F = 10 \text{ A}; $ $T_j = 25 ^{\circ}\text{C}$	-	22	-	nC



650 V, 10 A SiC Schottky diode in DPAK R2P

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	Α	anode		
mb	К	mounting base; connected to cathode	DPAK R2P (SOT8017)	K K; mb

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
<u>PSC1065H</u>		Plastic, single-ended surface-mounted package (DPAK R2P); Real-2-Pin configuration; 4.58 mm pitch; 6.16 mm x 6.54 mm x 2.29 mm body	SOT8017			

7. Marking

Table 4. Marking codes

Type number	Marking code
PSC1065H	PSC1065H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	650	V
dv/dt	diode dv/dt ruggedness	0 V ≤ V _R ≤ 480 V	-	100	V/ns
I _F	forward current	T _c ≤ 122 °C; δ = 1	-	10	Α
I _{FSM}	non-repetitive peak	t _p = 10 μs; square wave; T _c = 25 °C	-	440	Α
	forward current	t_p = 10 ms; half sine-wave; T_c = 25 °C	-	52	Α
		t_p = 10 ms; half sine-wave; T_c = 150 °C	-	42	Α
∫i ² dt	i ² t value	t _p = 10 ms; T _c = 25 °C	-	14	A²s
		t _p = 10 ms; T _c = 150 °C	-	9	A²s
P _{tot}	total power dissipation	T _c ≤ 25 °C	-	58	W
Tj	junction temperature		-	175	°C
T _{amb}	ambient temperature		-55	175	°C
T _{stg}	storage temperature		-65	175	°C

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-c)}	thermal resistance from junction to case		-	2	2.6	K/W

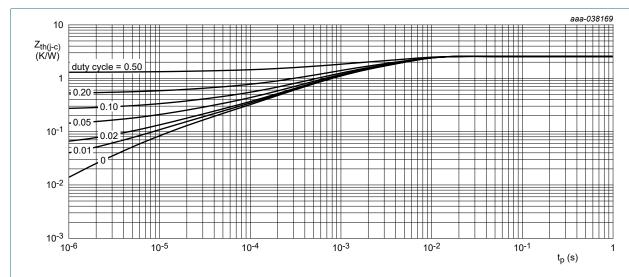


Fig. 1. Transient thermal impedance as a function of pulse duration; maximum values

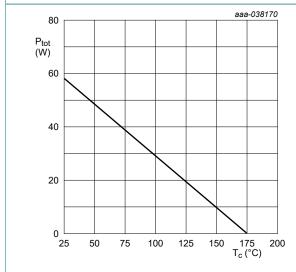


Fig. 2. Power dissipation; maximum values

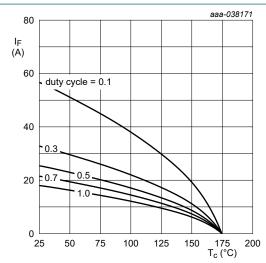


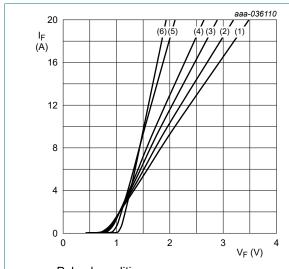
Fig. 3. Forward current as a function of case temperature; maximum values

650 V, 10 A SiC Schottky diode in DPAK R2P

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DC}	DC blocking voltage		650	-	-	V
V _F	forward voltage	I _F = 10 A; T _j = 25 °C	-	1.5	1.8	V
		I _F = 10 A; T _j = 150 °C	-	1.95	2.6	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C	-	1	60	μΑ
		V _R = 650 V; T _j = 150 °C	-	10	120	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	340	-	pF
		V _R = 400 V; f = 1 MHz; T _j = 25 °C	-	36	-	pF
Q _C	total capacitive charge	$V_R = 400 \text{ V}; \text{ dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s}; \text{ I}_F = 10 \text{ A}; $ $T_j = 25 \text{ °C}$	-	22	-	nC





(1)
$$T_j = 175 \,^{\circ}\text{C}$$

$$(2)$$
 $T_j = 150 °C$

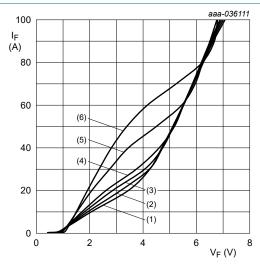
(3)
$$T_i = 125 \,^{\circ}\text{C}$$

$$(4) T_j = 100 °C$$

$$(5)$$
 $T_j = 25$ °C

$$(6)$$
 $T_i = -55$ °C

Fig. 4. Forward current as a function of forward voltage; typical values



Pulsed condition:

(1)
$$T_j = 175 \, ^{\circ}C$$

$$(2)$$
 $T_i = 150 °C$

(3)
$$T_i = 125 \,^{\circ}\text{C}$$

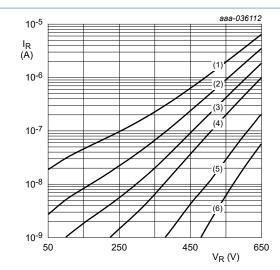
$$(4) T_j = 100 °C$$

$$(5)$$
 $T_j = 25$ °C

$$(6)$$
 $T_i = -55$ °C

Fig. 5. Forward characteristics in surge current as a function of forward voltage; typical values

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Pulsed condition:

(1) $T_j = 175 \, ^{\circ}C$

(2) $T_j = 150 \,^{\circ}\text{C}$ (3) $T_j = 125 \,^{\circ}\text{C}$ (4) $T_j = 100 \,^{\circ}\text{C}$

(5) $T_i = 25 °C$

 $(6) T_i = -55 °C$

Fig. 6. Reverse current as a function of reverse voltage; typical values

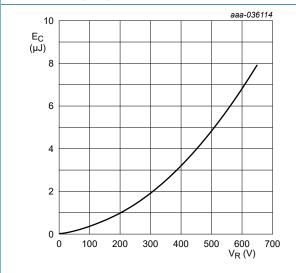
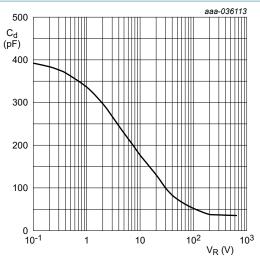
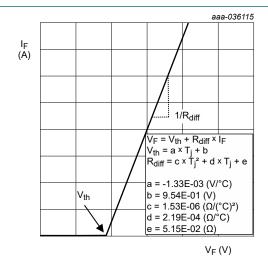


Fig. 8. Capacitance stored energy as a function of reverse voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$

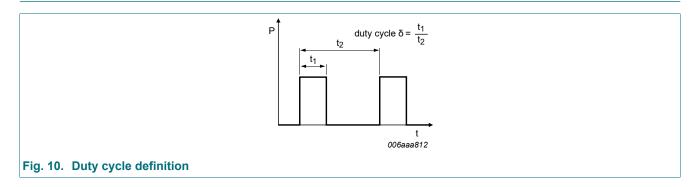
Fig. 7. Diode capacitance as a function of reverse voltage; typical values



Simplified forward characteristics mode

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11. Test information



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12. Package outline

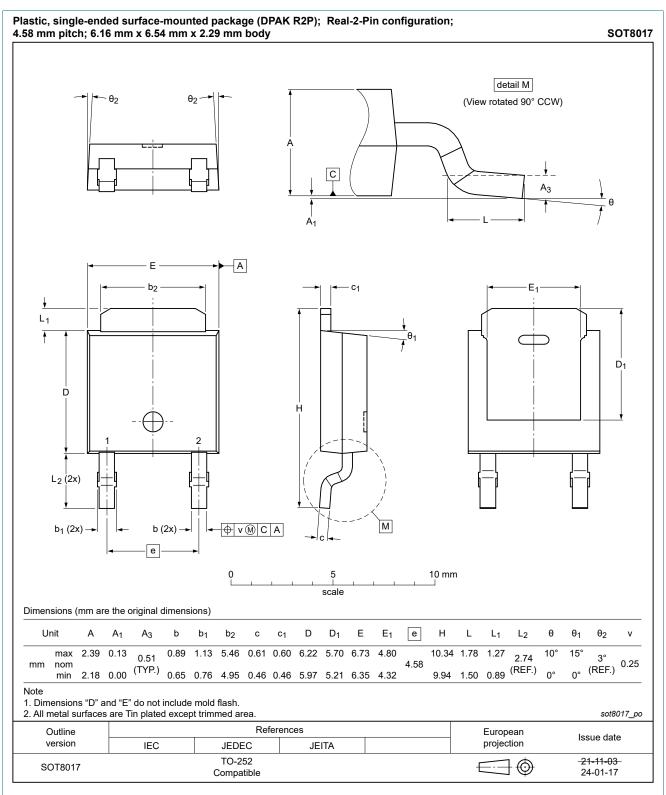
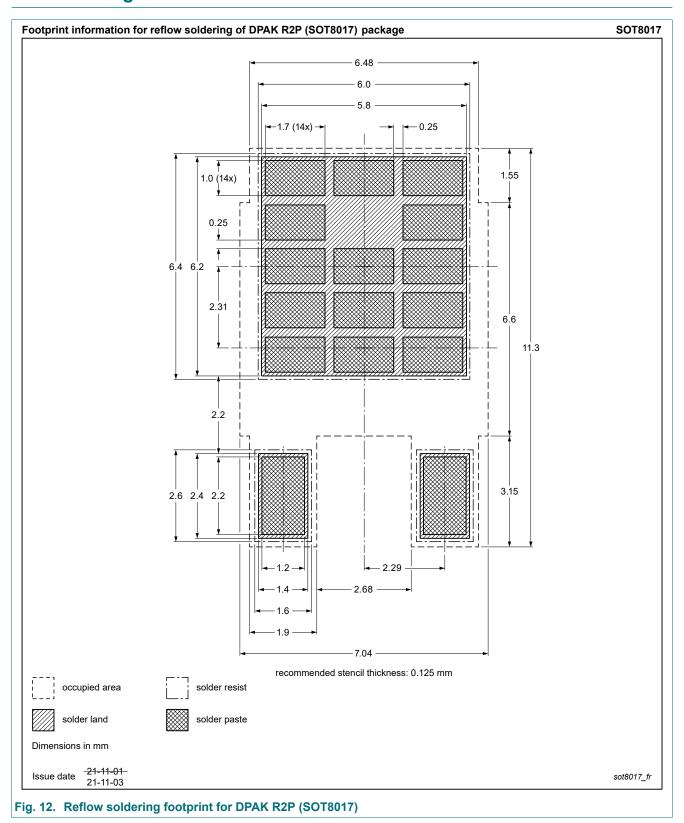


Fig. 11. Package outline DPAK R2P (SOT8017)

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13. Soldering



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14. Revision history

Table 8. Revision history

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PSC1065H v.2	20240208	Product data sheet	-	PSC1065H v.1			
Modifications:	Product status	Product status changed					
PSC1065H v.1	20231211	Preliminary data sheet	-	-			

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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